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Part Number: [0878322621](#)
Status: **Active**
Overview: milligrid
Description: 2.00mm (.079") Pitch Milli-Grid™ Header, Surface Mount, Vertical, Shrouded, Lead-free, 26 Circuits, 0.76µm (30µ") Gold (Au) Plating, with Locking Windows and Center Polarization Slot, PCB Locator, Tube

Documents:

[3D Model](#) [Product Specification PS-87831-027 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA LR19980
 UL E29179

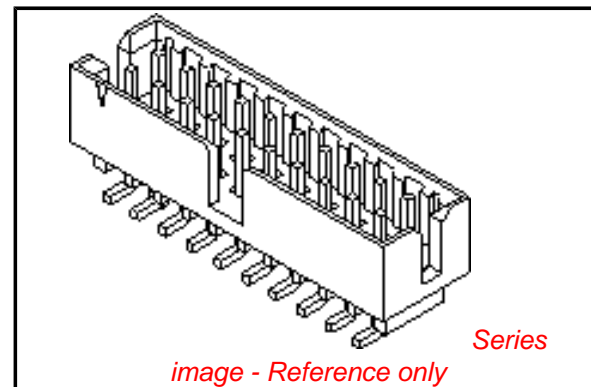
General

Product Family PCB Headers
 Series [87832](#)
 Application Signal, Wire-to-Board
 Comments Without Cap; Contact Molex for application in automotive industry
 Overview [milligrid](#)
 Product Name Milli-Grid™

Physical

Breakaway No
 Circuits (Loaded) 26
 Circuits (maximum) 26
 Color - Resin Black
 First Mate / Last Break No
 Flammability 94V-0
 Glow-Wire Compliant No
 Guide to Mating Part No
 Keying to Mating Part Yes
 Lock to Mating Part Yes
 Material - Metal Phosphor Bronze
 Material - Plating Mating Gold
 Material - Plating Termination Tin
 Material - Resin Nylon
 Number of Rows 2
 Orientation Vertical
 PCB Locator Yes
 PCB Retention None
 Packaging Type Tube
 Pitch - Mating Interface 2.00mm (.079")
 Pitch - Termination Interface 2.00mm (.079")
 Plating min - Mating 0.762µm (30µ")
 Plating min - Termination 1.905µm (75µ")
 Polarized to Mating Part Side Slots (2)
 Polarized to PCB No
 Shrouded Fully
 Stackable No
 Temperature Range - Operating -55°C to +105°C
 Termination Interface: Style Surface Mount

Electrical



EU RoHS

ELV and RoHS Compliant
REACH SVHC Contains SVHC: No
Low-Halogen Status Not Low-Halogen

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
 For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

[87832Series](#)

Mates With

50394 Wire-to-Board Terminals. 51110 Wire-to-Board Crimp Housing. 87568 Wire-to-Board IDT Housings. 79107 Board-to-Board Top Entry Through Hole Receptacle. 79108 Board-to-Board FFC/FPC Top Entry Through Hole Receptacle. L

Current - Maximum per Contact	2A
Voltage - Maximum	125V

Solder Process Data

Duration at Max. Process Temperature (seconds)	10
Lead-free Process Capability	Reflow Capable (SMT only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Product Specification	PS-87831-027
Sales Drawing	SD-87832-007

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